

Final Product/Process Change Notification Document #: FPCN22242Z

Document #: FPCN22242. Issue Date: 11 April 2018

Title of Change:	NCV7471 Datasheet update.		
Proposed Changed Material First Ship Date:	11 April 2019 or earlier upon customer approval.		
Product Category:	Active components – Integrated circuits		
Contact information:	Contact your local ON Semiconductor Sales Office or < <u>ondrej.kupcik@onsemi.com</u> >.		
Samples:	Contact your local ON Semiconductor Sales Office to place sample order. Sample requests are to be submitted no later than 45 days after publication of this change notification.		
Sample Availability Date:	3 April 2018		
PPAP Availability Date:	3 April 2018		
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or < <u>Catherine.DeKeukeleire@onsemi.com</u> >		
Type of Notification:	s is a Final Product/Process Change Notification (FPCN) sent to customers. Ns are issued 12 months prior to implementation of the change or earlier upon customer approval. Semiconductor will consider this proposed change and it's conditions acceptable, unless an inquiry is de in writing within 45 days of delivery of this notice. To do so, contact < PCN. Support@onsemi.com >.		
Data Sheet	Correction of data sheet / errata		

Description and Purpose:

Datasheet update:

- $\bullet \ I_VS \ parameter \ test \ conditions \ updated$
- I_VCC_CAN parameter test conditions updated
- tSCK_SDOlow limit changed to high limit
- NCV7471DQ5 OPN removed (Announced in PRODUCT DISCONTINUANCE # 20734 (14-Jan-2015))
- MSL level specification added (MSL = 2)

successfully passed the qualification tests. Pote ON Semiconductor in relation to the PCN, asso	ential impacts can be identified, but due to testing performed by		
The device has been qualified and validated based on the same Product Specification. The device has successfully passed the qualification tests. Potential impacts can be identified, but due to testing performed by ON Semiconductor in relation to the PCN, associated risks are verified and excluded. No anticipated impacts as already discussed and validated by customer.			
ON Semiconductor Sites: All Sites	External Foundry/Subcon Sites: None		
Affected products will be identified by datecode.			
	All Sites		

Reliability Data Summary:

N/A. See reliability data of original PPAP NCV7471.

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Electrical Characteristic Summary:

I_VS parameter test conditions updated

•Test condition modified – "Tj ≤ 85°C" added

I_VCC_CAN parameter test conditions updated

•Test condition modified – "Tj ≤ 85°C" added

tSCK_SDOlow limit changed to high limit

•Misplaced limit number corrected – moved from Low limit to High limit

List of Affected Standard Parts:

Current Part Number	New Part Number	Qualification Vehicle
NCV7471DQ5R2G	NCV7471DQ5R2G	NCV7471DQ5R2G
NCV7471ADQ5R2G	NCV7471ADQ5R2G	NCV7471ADQ5R2G

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Appendix A: Changed Products

Product	Customer Part Number	New Part Number	Qualification Vehicle
NCV7471ADQ5R2G		NA	NCV7471ADQ5R2G
NCV7471DQ5R2G		NA	NCV7471DQ5R2G